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Globalfoundries  
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Solutions Glo  
balfoundries

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Packaging SIA  
Webinar: Trends  
and Challenges in  
Semiconductor

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Packaging From

Sand to Silicon:

The Making of a

Microchip | Intel A

New Advanced IC

Packaging

Battlefield

Cadence Design

Systems Thermal

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Challenges In

Advanced

Packaging Silicon

Photonics Co-

Packaging Webcast

with IBM and

GLOBALFOUNDRIES

[Eng Sub]

Semiconductor

Package Overall:

Structure, Process

A New Era of

Advanced Package

Technology Mike

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Packaging Solutions  
Globalfoundries  
Kelly ISES Webinar

Inside The Worlds  
Largest

Semiconductor

Factory - BBC Click

Innovative ASM

printing

technologies for

advanced

packaging Brewer

Science | Advanced

Packaging: The

Road to the Future

[Eng Sub] Wafer

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Bumping Process:

Solder bump, Cu  
pillar bump, UBM

AEMtec Imagefilm

~~"From Wafer to~~

~~Packaging"~~ How

do they make

Silicon Wafers and

Computer Chips?

~~Presentation on the~~

~~Semiconductor~~

~~Industry, The~~

~~Players and The~~

~~Trends What's~~



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~~inside a microchip~~

2 Semiconductor

Technology at

TSMC, 2011 Chip

Manufacturing -

How are Microchips

made? | Infineon

Making Memory

Chips - Process

Steps ~~MICRONAS~~

~~Micronas Backend~~

~~Overview~~

---

What is Silicon

Wafer? ~~Why is~~

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~~advanced~~

~~packaging used in  
IC manufacturing?~~

~~Life at~~

~~GlobalFoundries 30  
years of IC~~

~~packaging 3D~~

~~Packaging is  
transforming the  
world of~~

~~Semiconductor~~

~~Packaging—~~

~~Webcast~~

GLOBALFOUNDRIES

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Building Fab 8 -

HardOCP

Automotive

Semiconductor

Packaging -

Trends, Challenges

and Solutions

GlobalFoundries

ITDC Fab 8

Packaging Part 6 -

Wafer to Panel

Level Packaging-

Alonso Lopez

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Packaging

Solutions

Globalfoundries

In a paper, Bruker

and

GlobalFoundries

have demonstrated

the ability to ... a

radius of 1nm to

measure 3nm

structures for in-

line metrology."

Metrology for

advanced

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packaging AFMs,  
meanwhile, also ...

Globalfoundries

Angstrom-Level  
Measurements  
With AFMs

This is evident in  
TSMC's earnings  
reports, which  
show a general  
downward trend for  
revenue obtained  
from advanced  
nodes over the ...

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having to venture into the finFET world. "Packaging in multi-die ...

Stepping Back From Scaling GF is one of only two companies in the world that delivers best-in-class IP plus advanced memory and packaging

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Solutions.

GLOBALFOUNDRIES  
is a leading full-  
service

semiconductor  
foundry providing a

...

GLOBALFOUNDRIES  
Demonstrates 2.5D  
High-Bandwidth  
Memory Solution  
for Data Center,  
Networking, and

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# Cloud Applications

“To help address these challenges on new silicon

nodes, we are engaging early with partners to jointly develop packaging solutions ... and test.” GLOBALFOUNDRIES' new Fab 8 campus stands as one of the ...



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## GLOBALFOUNDRIES

Fab 8 Adds Tools  
To Enable 3D Chip  
Stacking at 20nm  
and Beyond

In addition to the industry-leading performance of our FETs, the key source of our differentiation is our expertise in packaging ...

Revenue for the

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Advanced Packaging Solutions Group, or ASG, was \$607.6 ...

Globalfoundries

ON Semiconductor Corporation's (ON) CEO Hassane El-Khoury on Q2 2021 Results - Earnings Call Transcript

It just so happens that The Wall Street Journal reported last week

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that Intel is  
tinkering with the  
idea of a \$30 billion  
deal to acquire  
GlobalFoundries ...  
company that  
Advanced Micro  
Devices ...

4 Dow Stocks With  
48% to 58%  
Upside, According  
to Wall Street  
No single integrate

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# packaging

technology can do

it all: they need to

be combined for

maximum

functionality. The

set of techniques

to do that – hybrid

or heterogeneous

integration – is a

key growth ...

## Heterogeneous

## integration key to

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future integrated-  
photonics growth

This amount does  
not include

transactions

between

semiconductor

capital equipment

suppliers, material

producers, chip

packaging and

testing companies

... That month,

Marvell also said it

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would acquire ...

Solutions

Growth returns to  
semiconductor and

EDA tools M&A

markets - for now

Designed by BAE

Systems and

manufactured by

GLOBALFOUNDRIES

® (GF ®), the ... so

ftware-compatible

processing that is

more advanced

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than the RAD750  
radiation-hardened  
general purpose  
processor ...

BAE Systems  
Collaborates With  
GLOBALFOUNDRIES  
to Produce  
Radiation-  
Hardened Single  
Board Computers  
for Space  
In addition to the

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industry-leading  
performance of our  
fabs, the key  
source of our

differentiation is  
our expertise in  
packaging ...

Revenue for the  
Advanced Solutions  
Group or ASG was  
\$607.6 ...

ON Semiconductor  
Corporation (ON)



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Q2 2021 Earnings

Call Transcript

Quantum

computing is

anticipated to

unlock the

solutions ... using

the advanced

semiconductor

tools in the

production line of

PsiQuantum's

manufacturing

partner

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GlobalFoundries.

Solutions

PsiQuantum Closes  
\$450 Million

Funding Round to  
Build the World's  
First Commercially  
Viable Quantum  
Computer

AnaSpec, Inc. is a  
leading provider of  
integrated  
proteomics  
solutions ...

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**GLOBALFOUNDRIES**  
is the world's first  
truly global leading-  
edge

semiconductor  
manufacturing  
company.

Launched in March  
2009 ...

Nanotechnology in  
California –  
companies,  
research, and

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degree programs

The company has reported

consolidated

revenues of

NT\$31,493 million

for September

2018, representing

a 14% increase on

month and 15.8%

increase on year.

For the second

quarter of 2018,

the company ...

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Packaging

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China OSATs  
strengthen QFN  
packaging

Globalfoundries  
capability for car  
chips

And here, what you have is somebody who makes a single crystal silicon in a giant ingot, and then they slice it into — the most advanced are ...

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affect a lot of the  
packaging factories  
there.

**Globalfoundries**

Why the global  
chip shortage is  
making it so hard  
to buy a PS5

DUBLIN, August 03,  
2021--(BUSINESS  
WIRE)--The "Global  
Beer Packaging  
Market 2021-2025"  
report has been

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Added to Research  
AndMarkets.com's  
offering. The beer  
packaging market  
is poised to grow  
by \$1.45 ...

Global Beer  
Packaging Market  
2021-2025 - Resear  
chAndMarkets.com  
July 26 (Reuters) -  
Intel Corp  
<INTC.O>::INTEL

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ACCELERATES  
PROCESS AND  
PACKAGING INNOV  
ATIONS. INTEL ...  
WILL BE FIRST  
CUSTOMER TO USE  
IFS PACKAGING  
SOLUTIONS. INTEL  
CORP - INTEL 3  
WILL BE READY ...

Intel Corporation  
chemicals and  
advanced



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**Packaging**

**Solutions**  
materials,  
consumer goods &  
food, energy &  
power,

**Globalfoundries**  
manufacturing &  
construction,  
industrial

automation &  
equipment and  
agriculture & allied  
activities amongst  
others.

SRAM and ROM

*Page 33/35*

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**Design IP Market  
Outlook, Size,  
Share, Revenue,  
Regions & Forecast**

BAE Systems' radiation-hardened RAD510□ System on Chip (SoC) for space-based computing is entering fabrication.

Designed by BAE Systems and

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manufactured by G

LOBALFOUNDRIES

® (GF®), the

RAD510 SoC will ...

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